

Electronic Acknowledgement Receipt

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Application Number:	10722838
International Application Number:	
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Title of Invention:	Method of packaging at a wafer level
First Named Inventor/Applicant Name:	Suan Jeung Boon
Customer Number:	21186
Filer:	Suneel Arora/Amy Moriarty
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1		303601US3OARESPONSE.PDF	1041135 748749b9f9d670a9342c4a1d555905d888532562	yes	33
	Multipart Description/PDF files in .zip description				
	Document Description		Start	End	
	Miscellaneous Incoming Letter		1	1	
	Amendment/Req. Reconsideration-After Non-Final Reject		2	2	
	Specification		3	3	
	Applicant Arguments/Remarks Made in an Amendment		4	4	
	Specification		5	5	
	Claims		6	10	
	Applicant Arguments/Remarks Made in an Amendment		11	17	
	Drawings-only black and white line drawings		18	29	
	Information Disclosure Statement Letter		30	32	
	Information Disclosure Statement (IDS) Filed (SB/08)		33	33	
Warnings:					
Information:					
2	Foreign Reference	04290424.pdf	305314 608420d03cfb7058d5469bc9ddc5dcd5b295e40	no	7
Warnings:					
Information:					
3	Foreign Reference	09219449.pdf	494873 d471165d575d07289d343a57041bde0d5b81f574	no	10
Warnings:					
Information:					

4	Fee Worksheet (PTO-06)	fee-info.pdf	29964 5f5634dbc853a550a9139650e5797203cf8ce6d9	no	2
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